

### AUDI SQ7 HYBRID 48V/12V DC-DC CONVERTER

**February 2018**, LTEC Corporation released a new analysis report of the Audi SQ7 Hybrid car 48V/12V DC-DC converter manufactured by Bosch. European car makers are developing 48V Hybrid system to improve cost, efficiency and fuel consumption, and we believe, this DC-DC converter is a significant step moving forward. The Audi SQ7 model is the first 48V Hybrid system deployed in an Audi model.

Basic features:

- ▶ Bidirectional multiphase buck-boost converter
- ▶ Multiphase trans-linked buck-boost converter
- ▶  $\geq 96\%$  efficiency
- ▶ 48/12 V bi-directional input/output voltage
- ▶ Up to 3 kW continuous rated output
- ▶ Weight: 2.7 kg
- ▶ Dimensions: 220 x 183 x 75 mm



**DC-DC module**

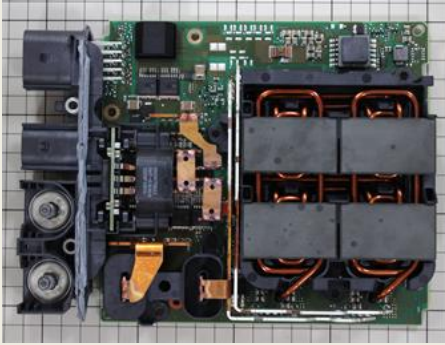
- Products consists of top housing, bottom housing, connector cover, bus bar module, main board and capacitor board.
- The main board configuration is Internal Power Supply, 48V Side Switch, 12V Side Switch, CAN Communication, 4 Phase Step-down Converter, MCU, Peripherals, High Voltage Logics.
- DCDC convertor has Bidirectional circuit configuration. In both directions, the secondary side output is synchronous rectification type.
- And also it has four-phases system. Unique inductor configuration is used , and it realize the thinner structure.
- The circuit configuration of the 4 phase DC - DC converter has characteristics of the inductor configuration, making it slimmer.
- The current detection is a normal configuration using a shunt resistor on the 48 V side, however it is a configuration that uses ON resistance on the 12 V side.
- 57 pages report includes the layout of each layers, detailed circuit diagram, functional block diagram, parts list and simulation result.

**Priced to sell at \$18,400**

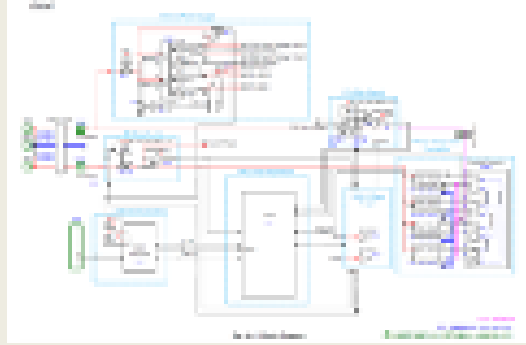
Note: The listed report price may not be accurate as it decreases over time.

Please contact us for current report pricing : [info@ltecusa.com](mailto:info@ltecusa.com)

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**Control board**



**Function block diagram**

## Table of Contents

	<b>Page</b>
Analysis summary	3
Product overview	6
Teardown (Mainboard, Capacitor board, Bass module board)	8
X-ray image of each PCBs	12
PCB layout image of each layers	16
Component details (Mainboard, Capacitor board)	18
Interface (Mainboard, Capacitor board)	32
Sensor	35
Inductor	36
Function block identification	39
Schematic	40
Component list	41
Simulation	53

17G-0023-1